

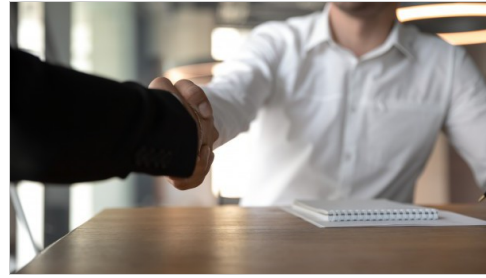
Tata Electronics and Bosch collaborate on semiconductor manufacturing

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The MOU aims to enhance chip packaging and EMS for vehicle electronics through future facilities in Assam and Gujarat

According to a press release on July 17, Tata Electronics and Robert Bosch GmbH have signed a memorandum of understanding (MOU) to collaborate in the electronics and semiconductor industries. The agreement was signed by Randhir Thakur, CEO and managing director of Tata Electronics, and Dirk Kress, executive vice president of Semiconductor Operations at Robert Bosch GmbH.



Source: Getty Images/ fizkes

The collaboration will focus on chip packaging and manufacturing at Tata Electronics' forthcoming assembly and test unit in Assam, India, as well as its foundry in Gujarat, India. Additionally, the two companies plan to explore opportunities in electronic manufacturing services (EMS) for vehicle electronics that would be mutually beneficial.

Kress said: “Bosch recognises the increasing demand for advanced automotive electronics and their critical role in shaping the future of mobility. To address the growing needs and foster supply chain resilience, Bosch is pleased to foster partnership with Tata Electronics, a key player and innovation leader in the Indian market. This move signifies Bosch's and Tata Electronics' commitment to local collaboration and acknowledges the strategic importance of the burgeoning automotive sector in India.”

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